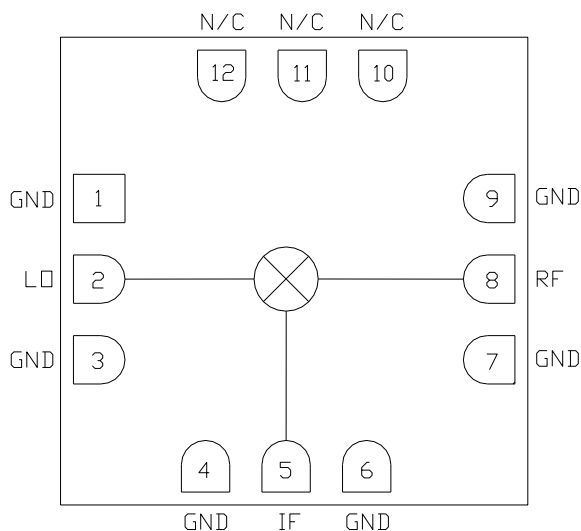


Product Overview

The CMD178C3 is a general purpose double balanced mixer in a leadless surface mount package that can be used for up- and downconverting applications between 11 and 20 GHz. The CMD178C3 has very high isolation to both the RF and IF ports due to the optimized balun structures, and can operate with an LO drive level as low as +9 dBm. The CMD178C3 can easily be configured as an image reject mixer or single sideband modulator with external hybrids and power splitters.

Functional Block Diagram



Key Features

- Low Conversion Loss
- High Isolation
- Wide IF Bandwidth
- Passive Double Balanced Topology
- Pb-Free RoHS Compliant 3x3 mm SMT Package

Ordering Information

Part No.	Description
CMD178C3	100 Piece 7" Reel
CMD178C3-EVB	1 Piece Bag

Electrical Performance (IF = 100 MHz, LO = +13 dBm, T_A = 25° C, F = 15 GHz)

Parameter	Min	Typ	Max	Units
Frequency Range, RF & LO		11 - 21		GHz
Frequency Range, IF	DC		6	GHz
Conversion Loss		6		dB
LO to RF Isolation		45		dB
LO to IF Isolation		45		dB
RF to IF Isolation		26		dB
Input P1dB		9		dBm

Unless otherwise noted, all measurements performed as a downconverter, IF = 100 MHz

Absolute Maximum Ratings

Parameter	Rating
RF / IF Input Power	+22 dBm
LO Drive	+22 dBm
Operating Temperature	-40 to 85° C
Storage Temperature	-55 to 150° C
Thermal Resistance, Q_{JC}	472° C/W
Power Dissipation, P_{diss}	138 mW

Exceeding any one or combination of the maximum ratings may cause permanent damage to the device.

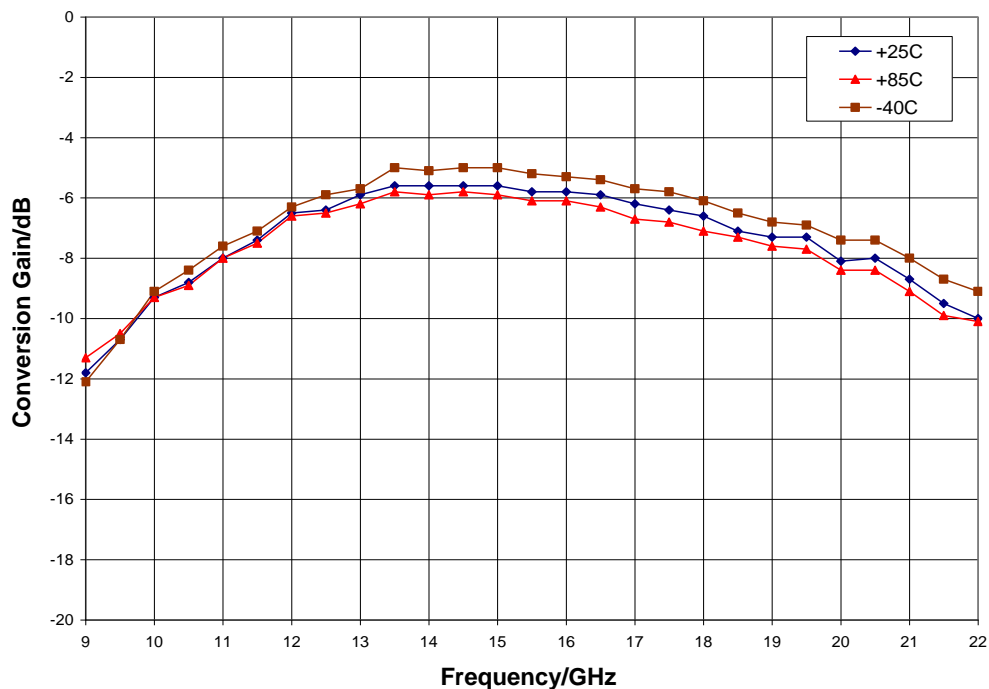
Electrical Specifications (IF = 100 MHz, LO = +13 dBm, T_A = 25° C)

Parameter	Min	Typ	Max	Min	Typ	Max	Units
Frequency Range, RF & LO	13 - 17			11 - 21			GHz
Frequency Range, IF	DC		6	DC		6	GHz
Conversion Loss		6	8		7	10	dB
Noise Figure (SSB)		6	8		7	10	dB
LO to RF Isolation	35	43		31	43		dB
LO to IF Isolation	33	48		30	38		dB
RF to IF Isolation	17	25		15	25		dB
Input P1dB		9			9		dBm
Input IP3		16			16		dBm

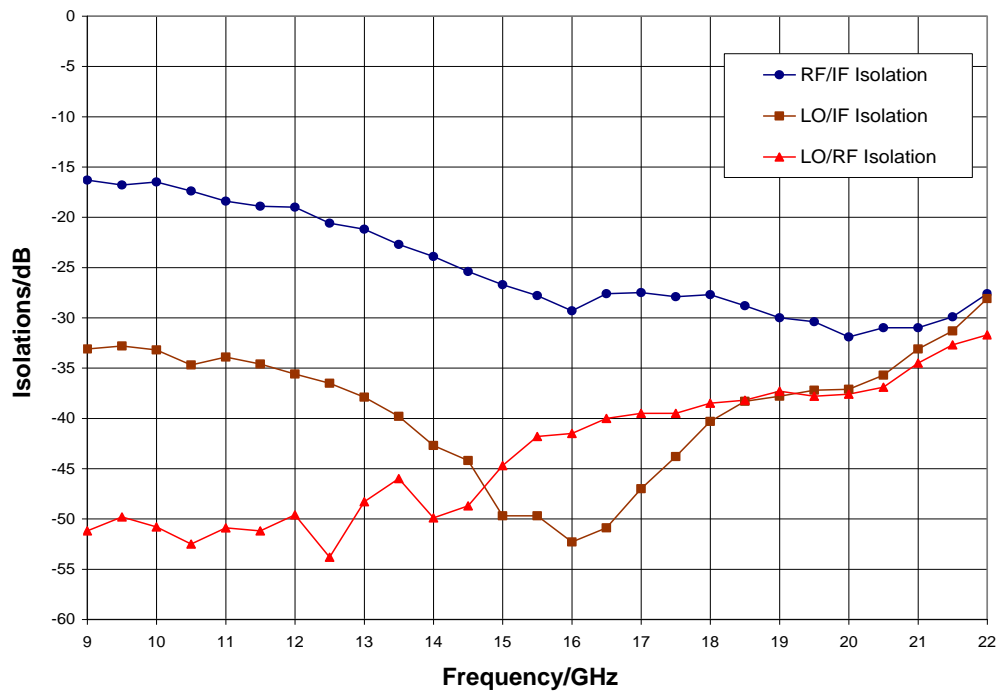
Unless otherwise noted, all measurements performed as a downconverter, IF = 100 MHz

Typical Performance

Conversion Gain vs. Temperature, LO = +13 dBm, IF = 100 MHz USB

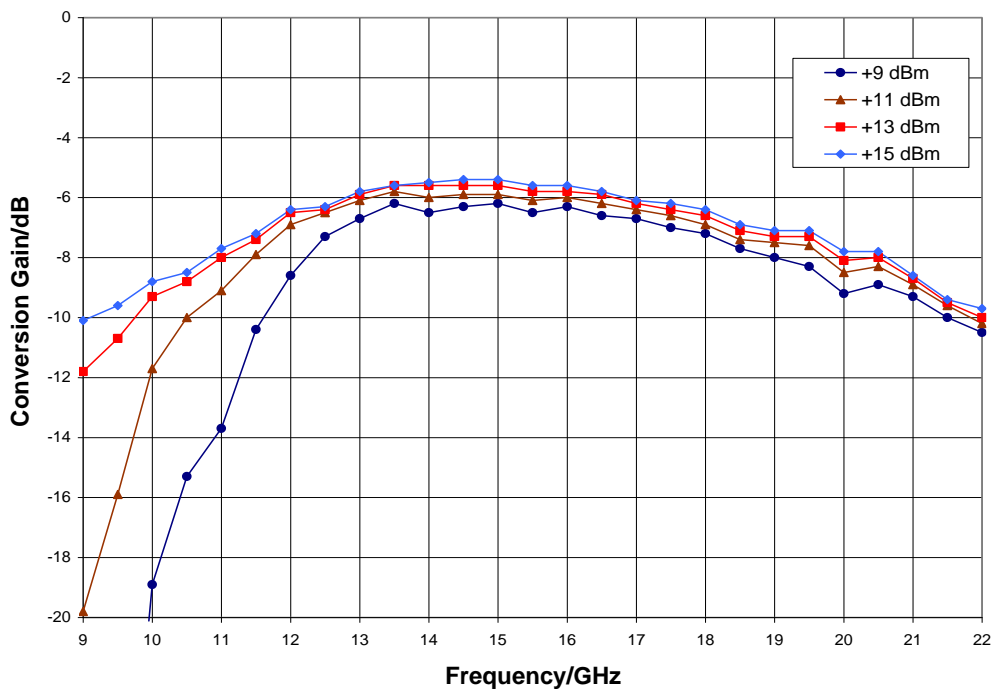


Isolation, LO = +13 dBm

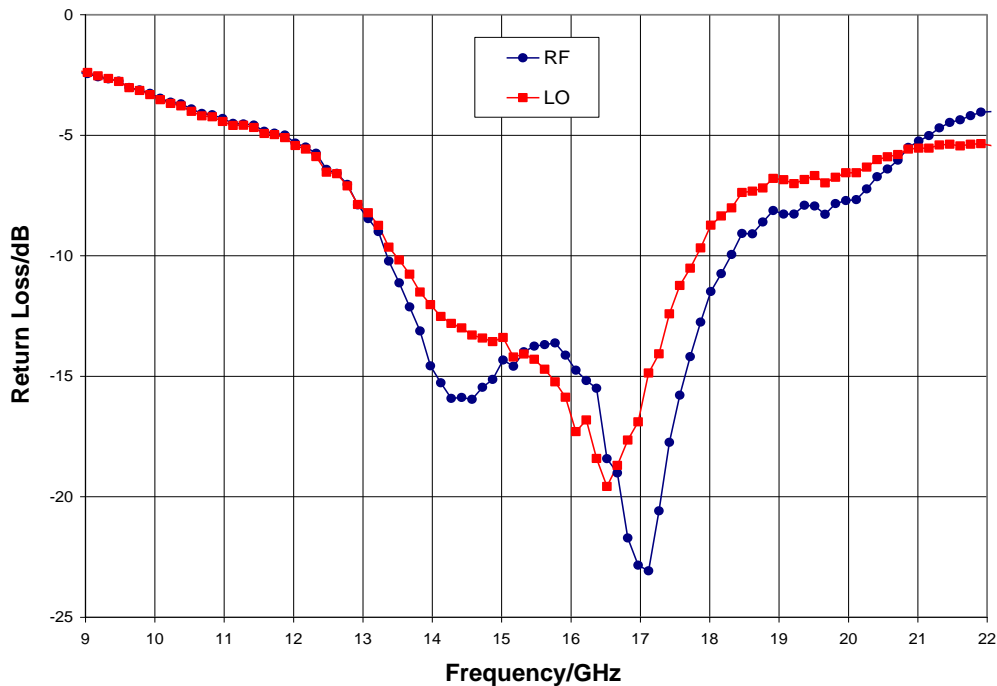


Typical Performance

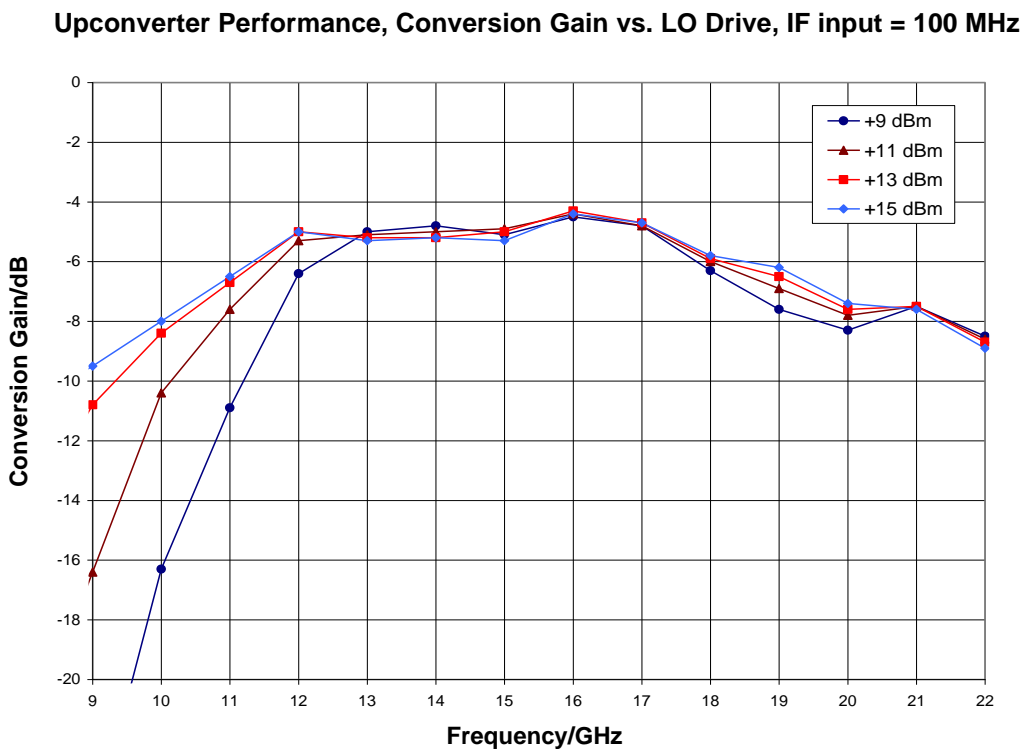
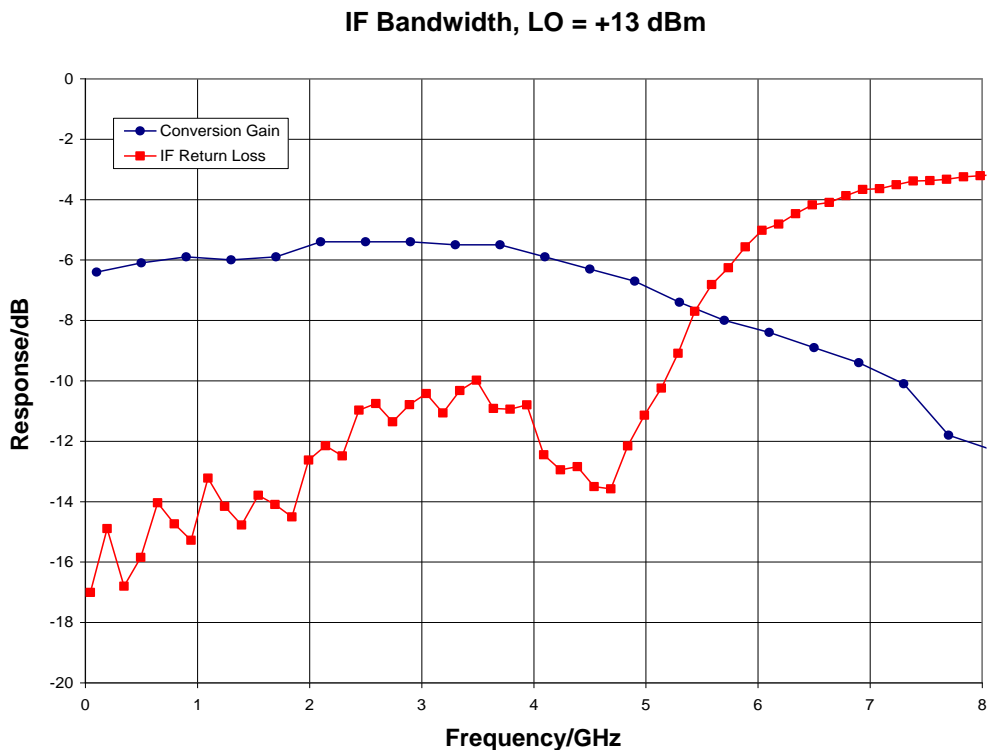
Conversion Gain vs. LO Drive, IF = 100 MHz USB



Return Loss, LO = + 13 dBm

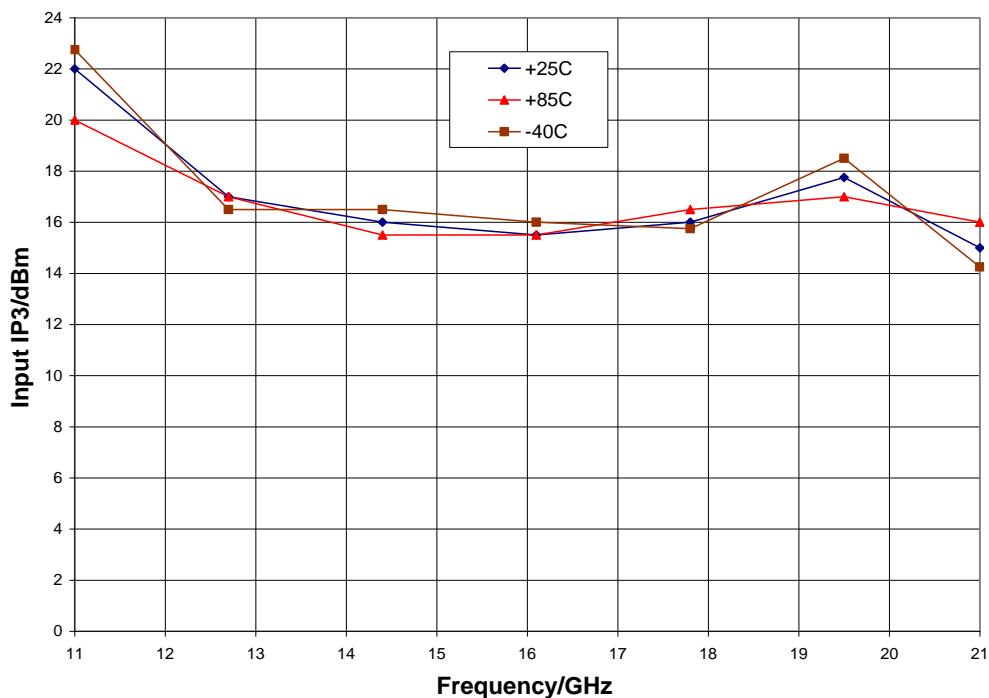


Typical Performance

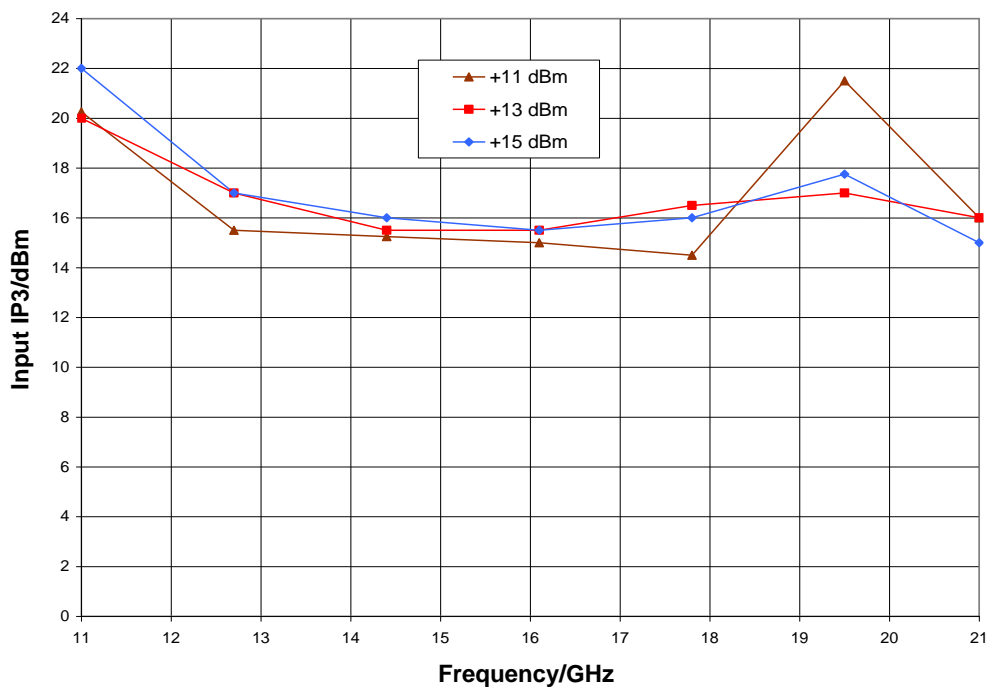


Typical Performance

Input IP3 vs. Temperature, LO = +13 dBm, IF = 100 MHz

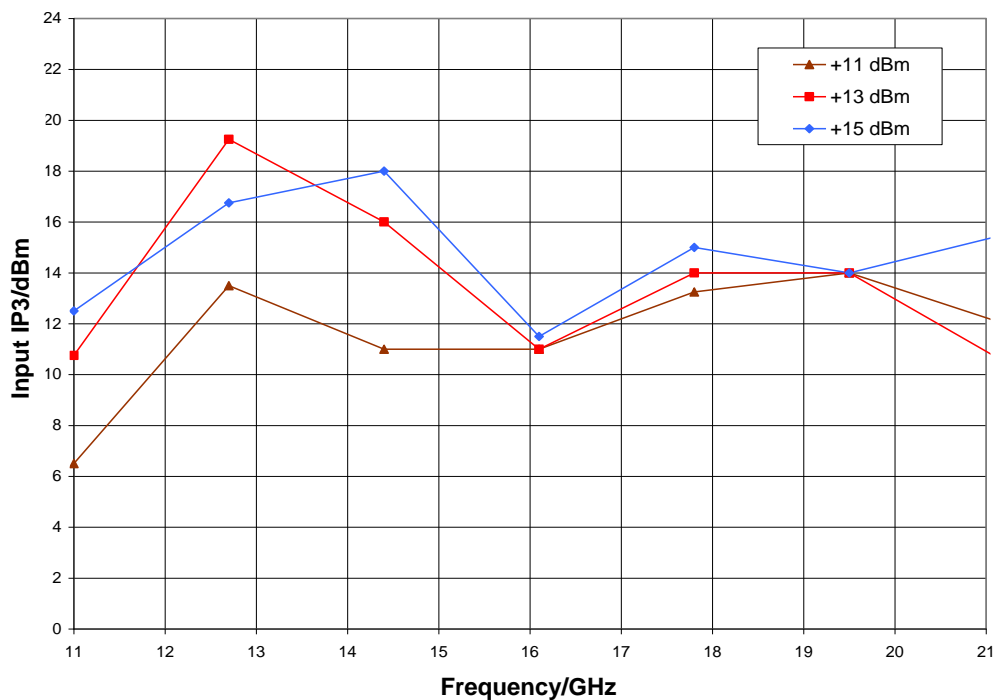


Input IP3 vs. LO Drive, IF = 100 MHz

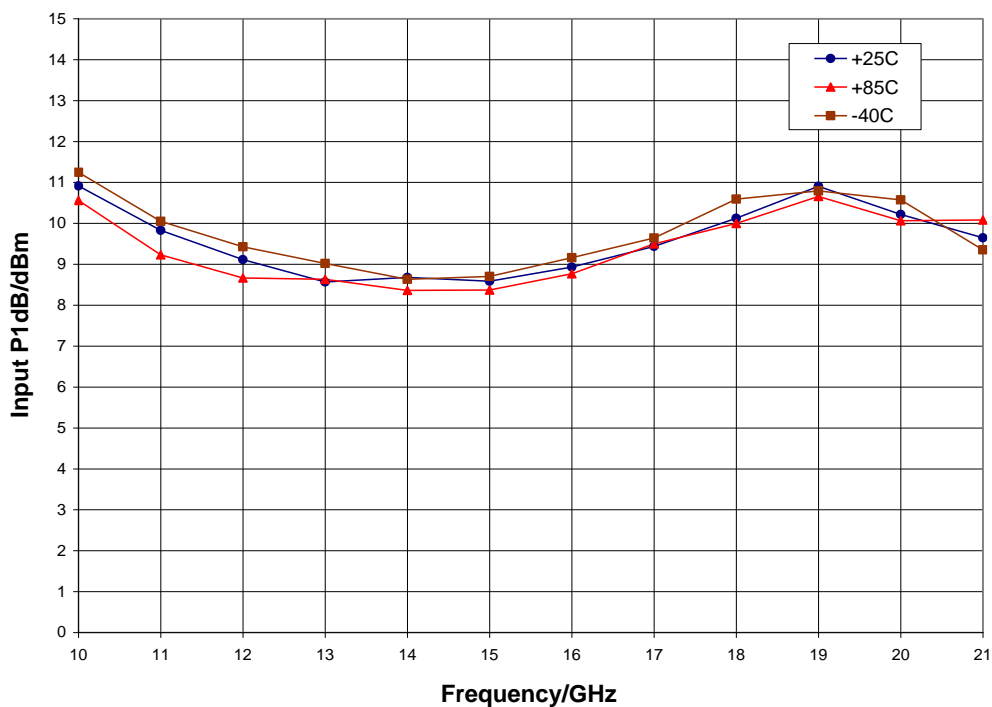


Typical Performance

Upconverter Performance, Input IP3 vs. LO Drive, IF = 500 MHz



Input P1dB vs. Temperature, LO = +13 dBm, IF = 100 MHz USB



Typical Performance

MxN Spurious Outputs

mRF	nLO				
	0	1	2	3	4
0	xx	25	33	> 90	> 90
1	28	0	47	40	> 90
2	72	64	64	67	75
3	> 90	> 90	> 90	64	> 90
4	> 90	> 90	> 90	> 90	> 90

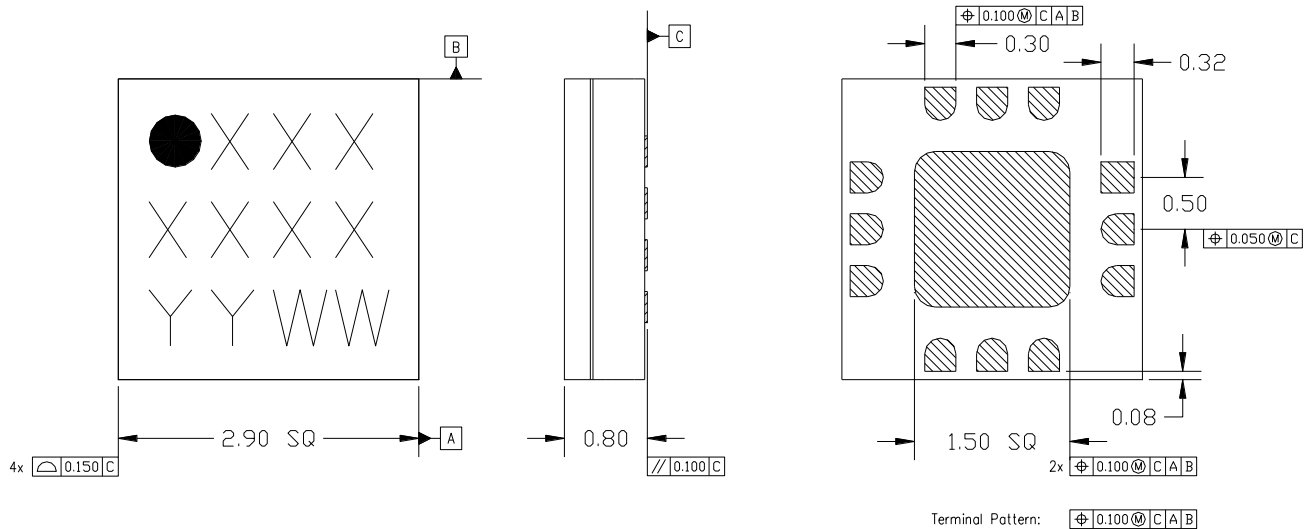
RF = 15.1 GHz @ -10 dBm

LO = 15.0 GHz @ +13 dBm

All values in dBc below the IF output power level (1RF - 1LO)

Mechanical Information

Package Information and Dimensions



Notes:

1. All dimensions shown in mm.
2. Material: Black alumina
3. Lead finish
 - 3.1. Ni: 8.89um max, 1.27um min
 - 3.2. Pd: 0.17um max, 0.07um min
 - 3.3. Au: 0.254um max, 0.03um min
4. Marking
 - 4.1. Line 1: Part number
 - 4.1.1. Example: CMD177C3 shall be marked as 177
 - 4.2. Line 2: Lot number
 - 4.3. Line 3: Date code – Last 2 digits of the year of manufacture followed by a 2 digit week code
5. Alternate pin #1 identifier is a single square pad
6. Alternate die paddle may have chamfered corners

Recommended PCB Land Pattern

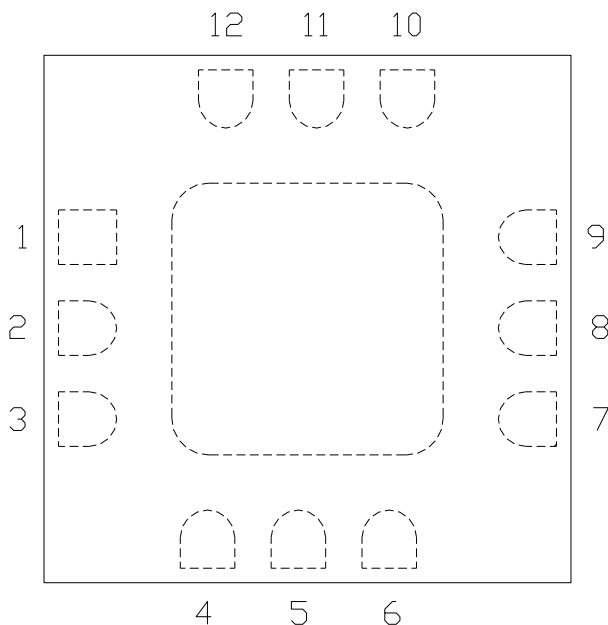
Qorvo recommends that the user develop the land pattern that will provide the best design for proper solder reflow and device attach for their specific application. Please review Qorvo Application Note AN 105 for a recommended land pattern approach.

Recommended Solder Reflow Profile

Qorvo recommends screen printing with belt furnace reflow to ensure proper solder reflow and device attach. Please review Qorvo Application Note AN 102 for a recommended solder reflow profile.

Pin Description

Pin Diagram



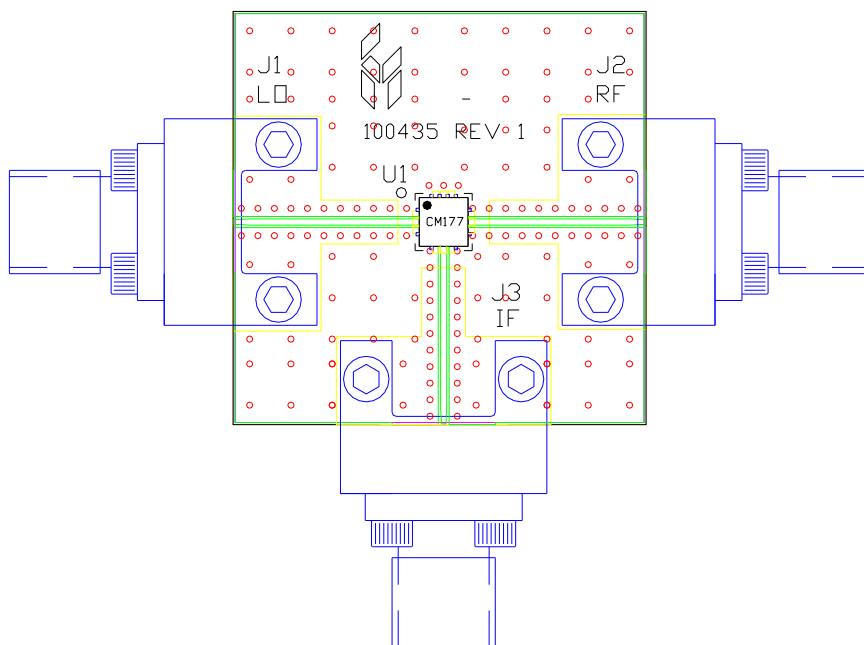
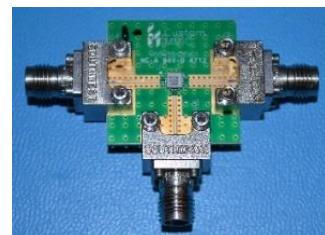
Functional Description

Pin	Function	Description	Schematic
1, 3, 4, 6, 7, 9 and die paddle	Ground	Connect to RF / DC ground	
2	LO	This pin is DC coupled and matched to 50 ohms	
5	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source or sink more than 16 mA of current or part non-function or part failure may result.	
8	RF	This pin is DC coupled and matched to 50 ohms	
10 - 12	N/C	No connection required These pins may be connected to RF / DC ground	

Applications Information

Evaluation Board

The circuit board shown has been developed for optimized assembly at Qorvo. A sufficient number of via holes should be used to connect the top and bottom ground planes. As surface mount processes vary, careful process development is recommended.



Bill of Material

Designator	Value	Description
J1 - J3		SMA End Launch Connector
U1		CMD178C3 Fundamental Mixer
PCB		100435 Evaluation PCB

GaAs MMIC devices are susceptible to damage from Electrostatic Discharge. Proper precautions should be observed during handling, assembly and test.

Handling Precautions

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 1A	ESDA / JEDEC JS-001-2012
MSL – Moisture Sensitivity Level	Level 1	JEDEC standard IPC/JEDEC J-STD-020



Caution!
ESD-Sensitive Device

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- SVHC Free
- Halogen free
- PFOS Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: www.qorvo.com

Tel: 1-844-890-8163

Email: customer.support@qorvo.com

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